IPC - ASSOCIATION CONNECTINE ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both lev	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information			
upplier Inform	ation													
Company name*			Company unique ID			U	Unique ID Authority				Response Date*			
nsemi											2025-05-06			
Contact Name			Title - Contact			P	Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			P	Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
Requeste	er Item Number	Mfr Item Number		Mfr Item Name]	Effective Date	Version	M	Ianufacturing Site	V	Veight*	UOM	Unit Type
		NCP8107	ICP81075MNTXG High Performance I		Dual MOSFET G	ate 2	2025-05-06	РНМ		3	8.61	mg	Each	
Ianufacturing	Proccess Informatio	on												
Terminal	Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-02			STD-020 MSL Ra	ating	Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles						eles		
Matte Tin (Sn) - annealed		C	CU Alloy 1				260	C 30		30	second	ls 3		
omments														
vel 1 - maximum t	ime at peak temperature	during sole	dering is 10-3	30 seconds						·				
or more informatio	on regarding material co	mposition r	olease refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its part and the supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such writte											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.4	mg	Supplier	Silicon (Si)	7440-21-3		0.4	mg
Die Attach	0.95	mg	Supplier	Silver (Ag)	7440-22-4		0.8075	mg
			Supplier	Acrylic resins	Proprietary Data		0.1425	mg
Lead Frame	14.94	mg	Supplier	Silver (Ag)	7440-22-4		2.9282	mg
			Supplier	Iron (Fe)	7439-89-6		0.1195	mg
			Supplier	Copper (Cu)	7440-50-8		11.8922	mg
Mold Compound-Black	20.0	mg	Supplier	Epoxy resins	129915-35-1		1	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1	mg
			Supplier	Carbon Black (C)	1333-86-4		0.08	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.46	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		17	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.46	mg
Plating	1.11	mg	Supplier	Tin (Sn)	7440-31-5		1.11	mg
Wire Bond	1.21	mg	Supplier	Palladium (Pd)	7440-05-3		0.0121	mg
			Supplier	Copper (Cu)	7440-50-8		1.1979	mg